



THE DATASHEET OF SP8M9TB



Switching

SP8M9

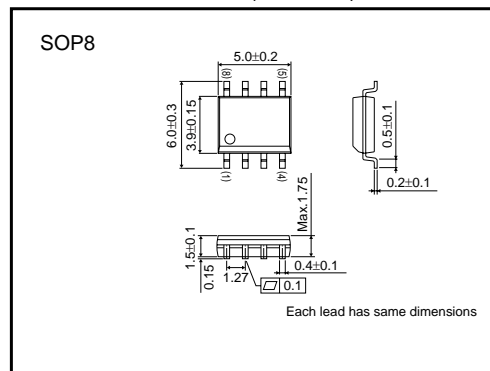
●Features

- 1) Low on-resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small and Surface Mount Package (SOP8).

●Application

Power switching, DC / DC converter.

●External dimensions (Unit : mm)

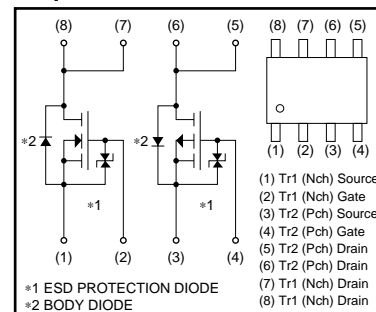


●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits		Unit
		Nchannel	Pchannel	
Drain-source voltage	V_{DSS}	30	-30	V
Gate-source voltage	V_{GSS}	20	-20	V
Drain current	Continuous	± 9.0	± 5.0	A
	Pulsed	± 36	± 20	A *1
Source current (Body diode)	Continuous	1.6	-1.6	A
	Pulsed	I_{SP}	-20	A *1
Total power dissipation	P_D	2		W *2
Channel temperature	Tch	150		°C
Storage temperature	Tstg	-55 to +150		°C

*1 $P_w \leq 10 \mu s$, Duty cycles 1%
*2 MOUNTED ON A CERAMIC BOARD.

●Equivalent circuit



*1 A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use the protection circuit when the fixed voltages are exceeded.

●Thermal resistance (Ta=25°C)

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth (ch-a)	62.5	°C / W *

*MOUNTED ON A CERAMIC BOARD.

Transistors

N-ch

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I _{GSS}	–	–	10	μA	V _{GS} =20V, V _{DS} =0V
Drain-source breakdown voltage	V _{(BR) DSS}	30	–	–	V	I _D =1mA, V _{GS} =0V
Zero gate voltage drain current	I _{DSS}	–	–	1	μA	V _{DS} =30V, V _{GS} =0V
Gate threshold voltage	V _{GS(th)}	1.0	–	2.5	V	V _{DS} =10V, I _D =1mA
Static drain-source on-state resistance	R _{DS(on)}	–	12	18	mΩ	I _D =9.0A, V _{GS} =10V
		–	16	24		I _D =9.0A, V _{GS} =4.5V
		–	17	25		I _D =9.0A, V _{GS} =4V
Forward transfer admittance	Y _{fs}	7.0	–	–	S	I _D =9.0A, V _{DS} =10V
Input capacitance	C _{iss}	–	1190	–	pF	V _{DS} =10V
Output capacitance	C _{oss}	–	340	–	pF	V _{GS} =0V
Reverse transfer capacitance	C _{rss}	–	190	–	pF	f=1MHz
Turn-on delay time	t _{d(on)}	–	10	–	ns	I _D =4.5A, V _{DD} ≐15V
Rise time	t _r	–	15	–	ns	V _{GS} =10V
Turn-off delay time	t _{d(off)}	–	55	–	ns	R _L =3.33Ω
Fall time	t _f	–	22	–	ns	R _G =10Ω
Total gate charge	Q _g	–	15	21	nC	V _{DD} ≐15V
Gate-source charge	Q _{gs}	–	3.0	–	nC	V _{GS} =5V
Gate-drain charge	Q _{gd}	–	6.1	–	nC	I _D =9.0A

*Pulsed

●Body diode characteristics (Source-Drain Characteristics) (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V _{SD}	–	–	1.2	V	I _S =6.4A, V _{GS} =0V

*Pulsed

Transistors

P-ch

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	–	–	–10	μA	$V_{GS} = -20V, V_{DS} = 0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	–30	–	–	V	$I_D = -1mA, V_{GS} = 0V$
Zero gate voltage drain current	I_{DSS}	–	–	–1	μA	$V_{DS} = -30V, V_{GS} = 0V$
Gate threshold voltage	$V_{GS(th)}$	–1.0	–	–2.5	V	$V_{DS} = -10V, I_D = -1mA$
Static drain-source on-state resistance	$R_{DS(on)}$	–	30	42	m Ω	$I_D = -5.0A, V_{GS} = -10V$
		–	40	56		$I_D = -2.5A, V_{GS} = -4.5V$
		–	45	63		$I_D = -2.5A, V_{GS} = -4.0V$
Forward transfer admittance	$ Y_{fs} $	4.5	–	–	S	$I_D = -2.5A, V_{DS} = -10V$
Input capacitance	C_{iss}	–	1400	–	pF	$V_{DS} = -10V$
Output capacitance	C_{oss}	–	300	–	pF	$V_{GS} = 0V$
Reverse transfer capacitance	C_{rss}	–	230	–	pF	$f = 1MHz$
Turn-on delay time	$t_{d(on)}$	–	15	–	ns	$I_D = -2.5A, V_{DD} = -15V$
Rise time	t_r	–	30	–	ns	$V_{GS} = -10V$
Turn-off delay time	$t_{d(off)}$	–	80	–	ns	$R_L = 6\Omega$
Fall time	t_f	–	40	–	ns	$R_G = 10\Omega$
Total gate charge	Q_g	–	16	–	nC	$V_{DD} = -15V$
Gate-source charge	Q_{gs}	–	3.5	–	nC	$V_{GS} = -5V$
Gate-drain charge	Q_{gd}	–	6.5	–	nC	$I_D = -5.0A$

*Pulsed

●Body diode characteristics (Source-Drain Characteristics) (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V_{SD}	–	–	–1.2	V	$I_S = -1.6A, V_{GS} = 0V$

*Pulsed

Transistors

N-ch

●Electrical characteristic curves

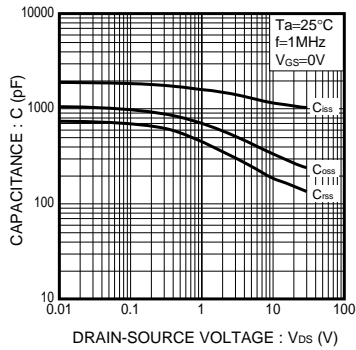


Fig.1 Typical Capacitance vs. Drain-Source Voltage

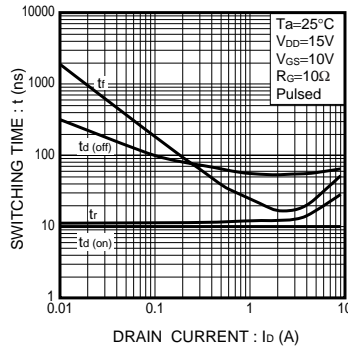


Fig.2 Switching Characteristics

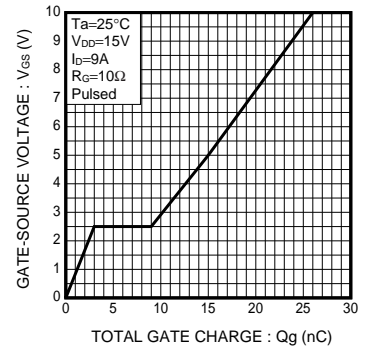


Fig.3 Dynamic Input Characteristics

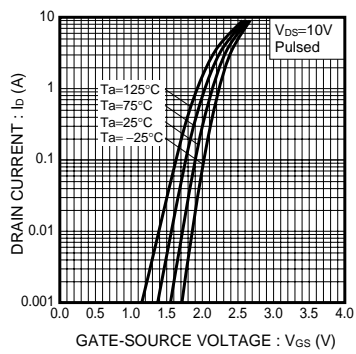


Fig.4 Typical Transfer Characteristics

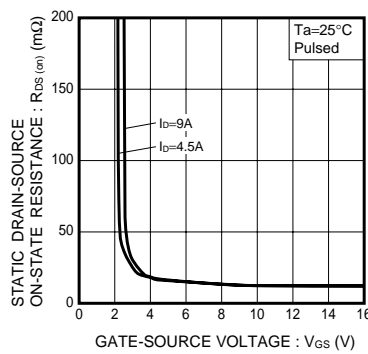


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

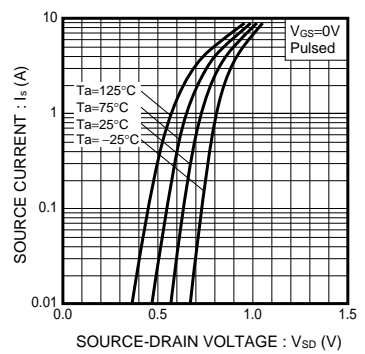


Fig.6 Source Current vs. Source-Drain Voltage

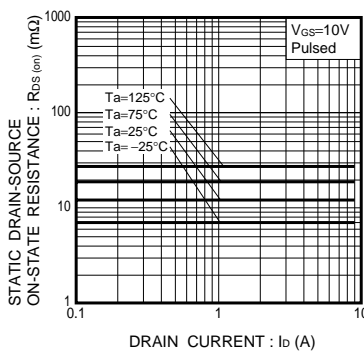


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (I)

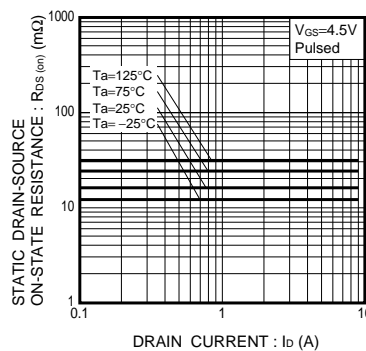


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (II)

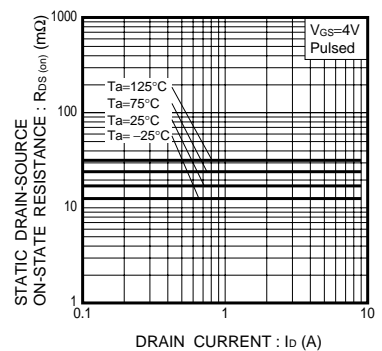


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current (III)

Transistors

P-ch

●Electrical characteristic curves

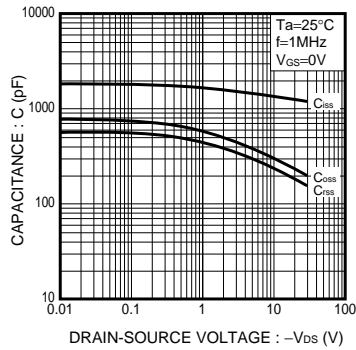


Fig.1 Typical Capacitance vs. Drain-Source Voltage

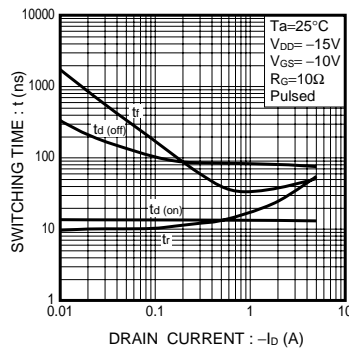


Fig.2 Switching Characteristics

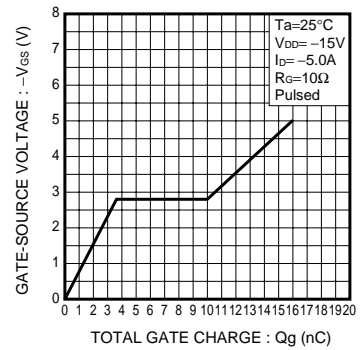


Fig.3 Dynamic Input Characteristics

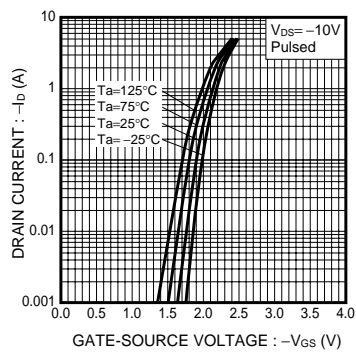


Fig.4 Typical Transfer Characteristics

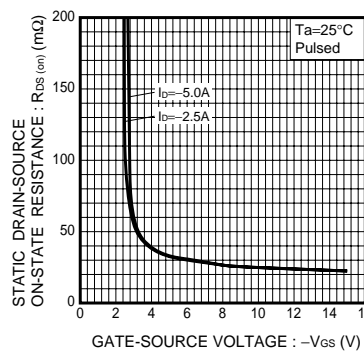


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

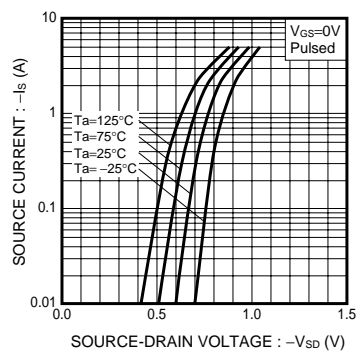


Fig.6 Source Current vs. Source-Drain Voltage

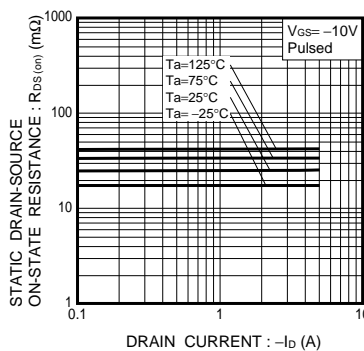


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (I)

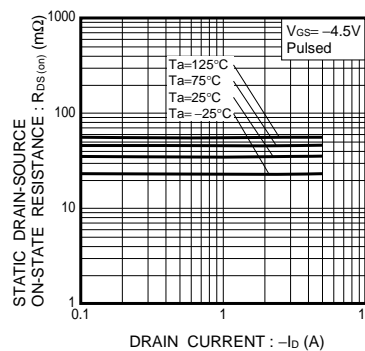


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (II)

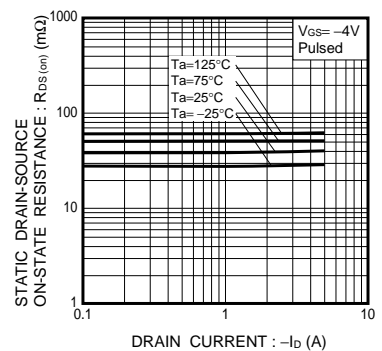


Fig.9 Static Drain-Source On-State Resistance vs. Drain Current (III)

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